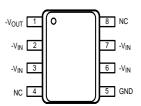


Descripion

This series of fixed-voltage monolithic integrated circuitvoltage regulators is designed for a wide range of applications. These applications include on-card regulation for elimination of noise and distribution problem sassociated with single-point regulation. Inaddition, they can be used with power-pass elements tomake high-current voltage regulators. Each of these regulators can deliver up to 100mA of output current. The internal limiting and termal shutdown features of these regulators make them essentially immune to overload. When used as a replacement for a Zener diode-resistor combination, an effective improvement in output impedance can be obtained together with lower-bias current.

Pin Configuration

SOP-8(SOIC-8)



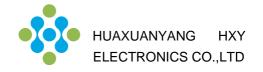


Features

- ·3-Terminal Regulators
- ·OutputCurrentUpto100mA
- ·NoExternalComponents
- ·InternalThermalOverloadProtection Internal Short-Circuit Limiting

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
Vı	Input voltage	-30	V
I _{CM}	Maximum output current	-100	mA
P _D	Power dissipation	500	mW
T _{OPR}	Operating junction temperature	0 to +125	$^{\circ}$
$T_{j,T_{stg}}$	Storage temperature range	-40 to +150	$^{\circ}$



Electrical Characteristics V_I=-10V, I_O=40mA

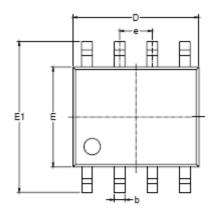
Parameter	neter Test Conditions*		Min	Тур	Max	Unit
Output voltage**		25°C	-4.8	-5	-5.2	V
	I _o =1mA to 40mA V _I =-7V to -20V	0 to 125 °C	-4.75	-5	-5.25	
	I _O =1mA to 70mA		-4.75	-5	-5.25	
Input regulation	V _i =-7V to -20V	25°C		15	150	mV
	V _I =-8V to -20V			12	100	
Ripple rejection	V _I =-8V to -18V, f=120Hz	25°C	41	49		dB
Output regulation	I _O =1mA to 100mA	25°C		20	60	mV
	I _O =1mA to 40mA			10	30	
Output noise voltage	f=10Hz-100Hz	25°C		40		μV
Dropout voltage		25°C		1.7		V
Bias current		25°C		3.8	6	mA
		125°C			5.5	
Bias current change	V _I =-8V to -20V	0 to 125 °C			1.5	
-	I ₀ =1mA to 40mA				0.1	

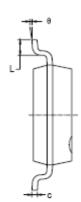
^{*}Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a $0.33\mu F$ capacitor across the input and a $0.1\mu F$ capacitor across the output.

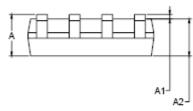
^{**}This specification applies only for dc power dissipation permitted by absolute maximum ratings.



SOP-8(SOIC-8) Package Information







Symbol	Dimensions In Millimeters		Dimensions In Inches	
,	MIN	MAX	MIN	MAX
Α	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
С	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
е	0°	8°	0°	8°



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